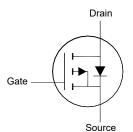
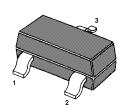
P-Channel Enhancement Mode MOSFET

Features

- Advanced trench cell design
- Extremely low threshold voltage





1. Gate 2. Source 3. Drain SOT-23 Plastic Package

Applications

- Portable appliances
- Battery management
- · High speed switch

Parameter	Symbol	Value	Unit
Drain-Source Voltage	-V _{DS}	20	V
Gate-Source Voltage	V _{GS}	± 12	V
Drain Current	-ID	3.5	А
Peak Drain Current, Pulsed ¹⁾	-I _{DM}	15	А
Total Power Dissipation	P _{tot}	1 ²⁾ 0.46 ³⁾	W
Operating Junction and Storage Temperature Range	Tj, Tstg	- 55 to + 150	°C

Thermal Resistance Ratings

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Ambient	R _{θJA}	125 ²⁾ 271 ³⁾	°C/W

¹⁾ Pulse Test: Pulse Width \leq 100 µs, Duty Cycle \leq 2%, Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C.

²⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate in still air.

³⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

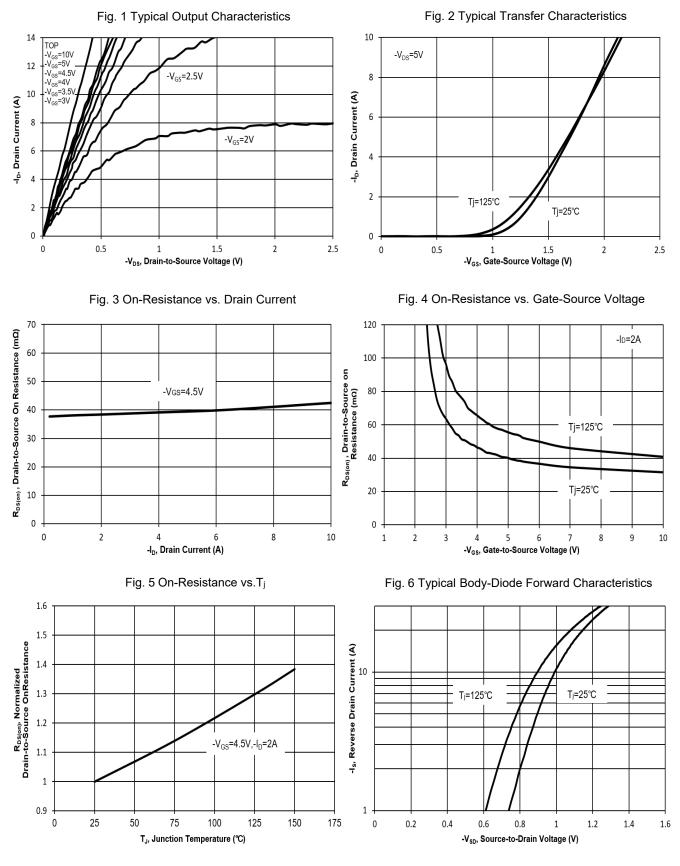


Characteristics at $T_a = 25^{\circ}C$ unless otherwise specified

Parameter	Symbol	Min.	Тур.	Max.	Unit
STATIC PARAMETERS					
Drain-Source Breakdown Voltage	-BV _{DSS}	20			V
at -I _D = 250 μA	-DVDSS	20	-	-	v
Drain-Source Leakage Current	-Ipss	-	_	1	μA
at -V _{DS} = 16 V	1000				μ.,
Gate Leakage Current	lgss	-	-	± 100	nA
at $V_{GS} = \pm 12 V$					
Gate-Source Threshold Voltage at $V_{DS} = V_{GS}$, $-I_D = 250 \ \mu A$	-V _{GS(th)}	0.4	-	1	V
Drain-Source On-State Resistance					
at $-V_{GS} = 4.5 \text{ V}, -I_D = 2 \text{ A}$	R _{DS(on)}	-	_	80	mΩ
at $-V_{GS} = 2.5 V$, $-I_D = 1.5 A$	T CDS(011)	-	-	130	11132
DYNAMIC PARAMETERS	I				
Forward Transconductance					
at $-V_{DS} = 5 \text{ V}, -I_D = 2 \text{ A}$	g fs	-	8.5	-	S
Gate resistance					
at $V_{DS} = 0 \text{ V}$, $V_{GS} = 0 \text{ V}$, f = 1 MHz	Rg	-	4.7	-	Ω
Input Capacitance	0		535		
at -V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	Ciss	-		-	pF
Output Capacitance	6		01		~_
at -V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	Coss	-	91	-	pF
Reverse Transfer Capacitance	Crss	-	64	-	pF
at -V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	Orss				
Total Gate Charge					
at -V _{GS} = 4.5 V, -V _{DS} = 10 V, -I _D = 2 A	Qg	-	5.7	-	nC
at $-V_{GS} = 2.5 \text{ V}, -V_{DS} = 10 \text{ V}, -I_D = 2 \text{ A}$			3.3	-	
Gate to Source Charge at $V_{ca} = 4.5 V_{ca} V_{ca} = 10 V_{ca} V_{ca} = 2.4$	Q _{gs}	-	1.7	-	nC
at $-V_{GS} = 4.5 \text{ V}, -V_{DS} = 10 \text{ V}, -I_D = 2 \text{ A}$					
Gate to Drain Charge at $V_{12} = 4.5 V_{12} V_{12} = 10 V_{12} V_{12} = 2.4$	Q_gd	-	1.6	-	nC
at $-V_{GS} = 4.5 \text{ V}, -V_{DS} = 10 \text{ V}, -I_D = 2 \text{ A}$	-				
Turn-On Delay Time at -V _{DD} = 10 V, -V _{GS} = 10 V, -I _D = 2 A, R _g = 3.3 Ω	t _{d(on)}	-	7	-	ns
Turn-On Rise Time					
at -V _{DD} = 10 V, -V _{GS} = 10 V, -I _D = 2 A, R _g = 3.3 Ω	tr	-	42	-	ns
Turn-Off Delay Time					
at $-V_{DD} = 10 V$, $-V_{GS} = 10 V$, $-I_D = 2 A$, $R_g = 3.3 \Omega$	t _{d(off)}	-	10	-	ns
Turn-Off Fall Time					
at $-V_{DD} = 10 \text{ V}, -V_{GS} = 10 \text{ V}, -I_D = 2 \text{ A}, \text{ R}_g = 3.3 \Omega$	t _f	-	7	-	ns
Body-Diode PARAMETERS	I				l
Diode Forward Voltage			l		
at $-I_s = 1 \text{ A}$, $V_{GS} = 0 \text{ V}$	-Vsd	-	-	1.2	V
Body Diodes Continuous Current	-ls		_	3.5	Α
•	-15	-	-	0.0	
Body Diode Reverse Recovery Time	trr	-	5.6	-	ns
at -I _S = 2 A, di/dt = 100 A / μs					
Body Diode Reverse Recovery Charge	Qrr	_	0.6	-	nC



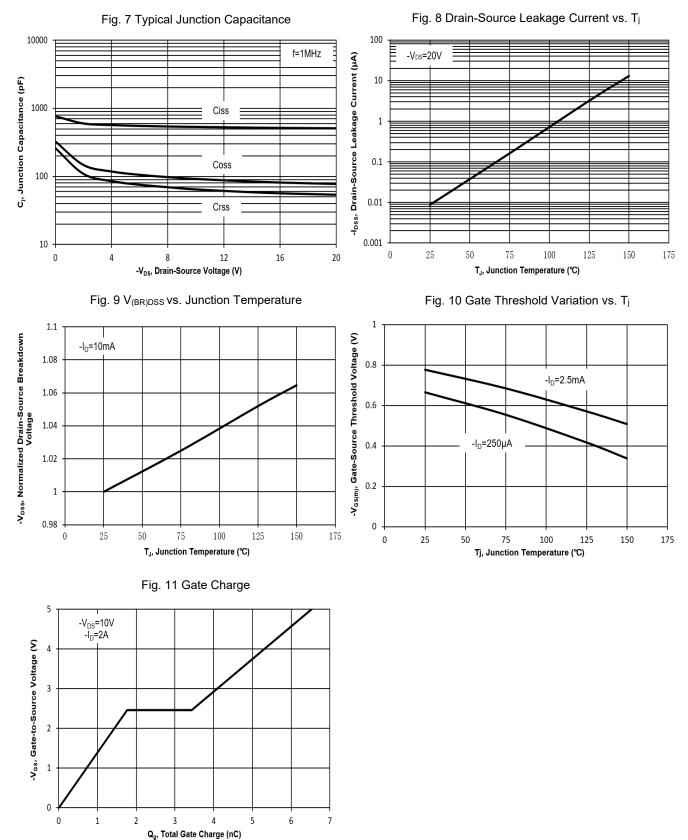
Electrical Characteristics Curves





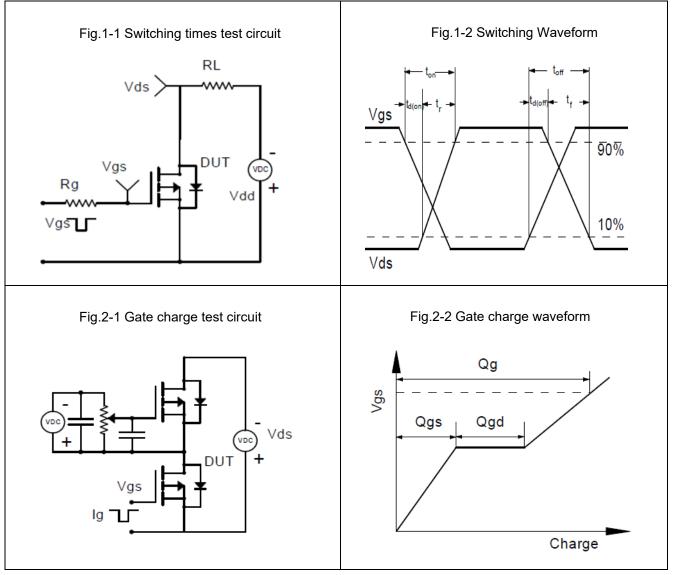
Dated: 06/03/2024 Rev:03

Electrical Characteristics Curves



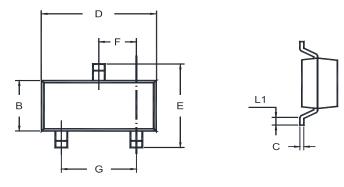


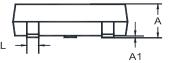
Test Circuits





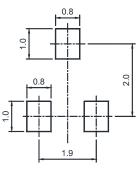
Package Outline (Dimensions in mm)





Unit	А	A1	В	С	D	E	F	G	L	L1
	1.20	0.100	1.40	0.19	3.04	2.6	1.02	2.04	0.51	0.2
mm	0.89	0.013	1.20	0.08	2.80	2.2	0.89	1.78	0.37	MIN

Recommended Soldering Footprint



Packing information

Tape Width		Pit	Pitch		Size		
Package	Package (mm)	mm	inch	mm	inch	Per Reel Packing Quantity	
SOT-23	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000	

Marking information

" YM " = Date Code Marking

" Y " = Year

" M " = Month

Font type: Arial

	Π
ΥM	V4

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